ON Semiconductor

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MOSFET – Power, N-Channel, SUPERFET[®] III, FRFET[®] 650 V, 65 A, 40 mΩ

NVH040N65S3F

Description

SUPERFET III MOSFET is ON Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate.

Consequently, SUPERFET III MOSFET is very suitable for the various power system for miniaturization and higher efficiency.

SUPERFET III FRFET MOSFET's optimized reverse recovery performance of body diode can remove additional component and improve system reliability.

Features

- 700 V @ $T_J = 150$ °C
- Typ. $R_{DS(on)} = 33.8 \text{ m}\Omega$
- Ultra Low Gate Charge (Typ. Q_g = 153 nC)
- Low Effective Output Capacitance (Typ. Coss(eff.) = 1333 pF)
- 100% Avalanche Tested
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

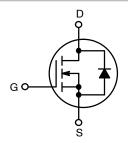
- Automotive On Board Charger HEV-EV
- Automotive DC/DC converter for HEV-EV



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V _{DSS}	R _{DS(ON)} MAX	I _D MAX
650 V	40 mΩ @ 10 V	65 A

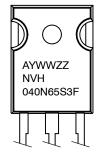


POWER MOSFET



TO-247-3LD CASE 340CK

MARKING DIAGRAM



NVH040N65S3F = Specific Device Code A = Assembly Plant Code YWW = Data Code (Year & Week)

ZZ = Lot

ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

ABSOLUTE MAXIMUM RATINGS ($T_C = 25^{\circ}C$, Unless otherwise noted)

Symbol	Parame	Value	Unit	
V_{DSS}	Drain to Source Voltage	oltage		V
V_{GSS}	GSS Gate to Source Voltage – DC		±30	V
		- AC (f > 1 Hz)	±30	
I _D	Drain Current	– Continuous (T _C = 25°C)	65	Α
		- Continuous (T _C = 100°C)	45	
I _{DM}	Drain Current	- Pulsed (Note 1)	162.5	А
E _{AS}	Single Pulsed Avalanche Energy (Note 2)	Single Pulsed Avalanche Energy (Note 2) Repetitive Avalanche Energy (Note 1)		
E _{AR}	Repetitive Avalanche Energy (Note 1)			
dv/dt	MOSFET dv/dt		100	V/ns
	Peak Diode Recovery dv/dt (Note 3)	50		
P_{D}	Power Dissipation	(T _C = 25°C)	446	W
		- Derate Above 25°C	3.57	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C
TL	Maximum Lead Temperature for Solderin	300	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Repetitive rating: pulse–width limited by maximum junction temperature.

2. $I_{AS} = 9 \text{ A}$, $R_G = 25 \Omega$, starting $T_J = 25^{\circ}C$.

3. $I_{SD} \le 32.5 \text{ A}$, $di/dt \le 200 \text{ A/µs}$, $V_{DD} \le 400 \text{ V}$, starting $T_J = 25^{\circ}C$.

THERMAL CHARACTERISTICS

Symbol	Symbol Parameter		Unit
$R_{ heta JC}$	R ₀ JC Thermal Resistance, Junction to Case, Max.		°C/W
$R_{\theta JA}$	R _{θJA} Thermal Resistance, Junction to Ambient, Max.		

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Marking	Package	Packing Method	Shipping (Qty / Packing)
NVH040N65S3F	NVH040N65S3F	TO-247 G03	Tube	30 Units / Tube

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
OFF CHARACT	ERISTICS			-	-	-
BV _{DSS}	Drain to Source Breakdown Voltage	$V_{GS} = 0 \text{ V, } I_D = 1 \text{ mA, } T_J = 25^{\circ}\text{C}$	650	-	_	V
		V _{GS} = 0 V, I _D = 10 mA, T _J = 150°C	700	-	-	V
$\Delta BV_{DSS} / \Delta T_{J}$	Breakdown Voltage Temperature Coefficient	I _D = 10 mA, Referenced to 25°C	-	0.64	-	V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 650 V, V _{GS} = 0 V	-	-	10	μΑ
		V _{DS} = 520 V, T _C = 125°C	-	103	-	
I _{GSS}	Gate to Body Leakage Current	$V_{GS} = \pm 30 \text{ V}, V_{DS} = 0 \text{ V}$	-	-	±100	nA
ON CHARACTE	RISTICS					
V _{GS(th)}	Gate Threshold Voltage	$V_{GS} = V_{DS}$, $I_D = 2.1 \text{ mA}$	3.0	-	5.0	V
R _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 32.5 A	-	33.8	40	mΩ
9FS	Forward Transconductance	V _{DS} = 20 V, I _D = 32.5 A	-	40	-	S
DYNAMIC CHAI	RACTERISTICS					
C _{iss}	Input Capacitance	$V_{DS} = 400 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	5875	_	pF
C _{oss}	Output Capacitance		-	140	-	pF
C _{oss(eff.)}	Effective Output Capacitance	V _{DS} = 0 V to 400 V, V _{GS} = 0 V	-	1333	-	pF
C _{oss(er.)}	Energy Related Output Capacitance	V _{DS} = 0 V to 400 V, V _{GS} = 0 V	-	241	-	pF
Q _{g(tot)}	Total Gate Charge at 10 V	V _{DS} = 400 V, I _D = 32.5 A, V _{GS} = 10 V	-	153	-	nC
Q _{gs}	Gate to Source Gate Charge	(Note 4)	-	51	-	nC
Q_{gd}	Gate to Drain "Miller" Charge		-	61	-	nC
ESR	Equivalent Series Resistance	f = 1 MHz		1.9	-	Ω
SWITCHING CH	IARACTERISTICS					
t _{d(on)}	Turn-On Delay Time	$V_{DD} = 400 \text{ V}, I_D = 32.5 \text{ A}, V_{GS} = 10 \text{ V}$	-	41	-	ns
t _r	Turn-On Rise Time	$R_g = 2.2 \Omega$ (Note 4)	_	53	-	ns
t _{d(off)}	Turn-Off Delay Time		-	96	-	ns
t _f	Turn-Off Fall Time		-	28	_	ns
SOURCE-DRAII	N DIODE CHARACTERISTICS					
I _S	Maximum Continuous Source to Drain Diode Forward Current		-	_	65	Α
I _{SM}	Maximum Pulsed Source to Drain Diode Forward Current		-	-	162.5	Α
V _{SD}	Source to Drain Diode Forward Voltage	V _{GS} = 0 V, I _{SD} = 32.5 A	-	-	1.3	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0 V, I _{SD} = 32.5 A,	-	159	-	ns
Q _{rr}	Reverse Recovery Charge	dI _F /dt = 100 A/μs	-	840	-	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Essentially independent of operating temperature typical characteristics.

TYPICAL CHARACTERISTICS

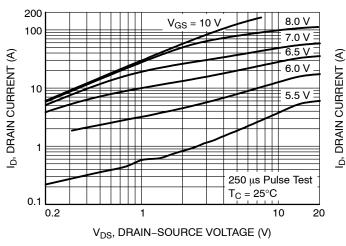


Figure 1. On-Region Characteristics

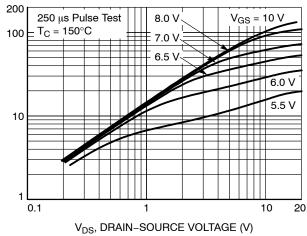


Figure 2. On-Region Characteristics

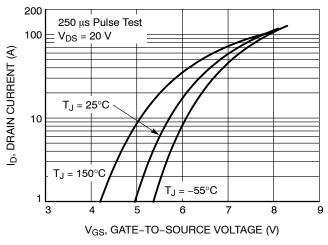


Figure 3. Transfer Characteristics

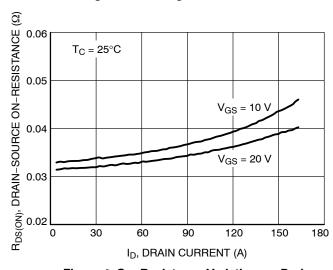


Figure 4. On-Resistance Variation vs. Drain Current and Gate Voltage

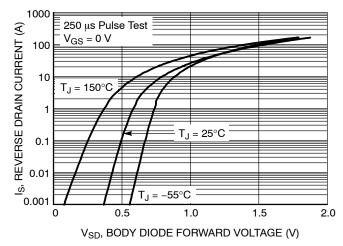
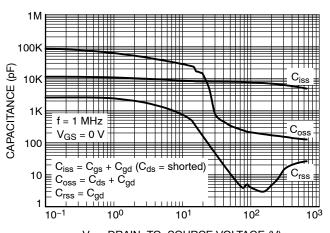


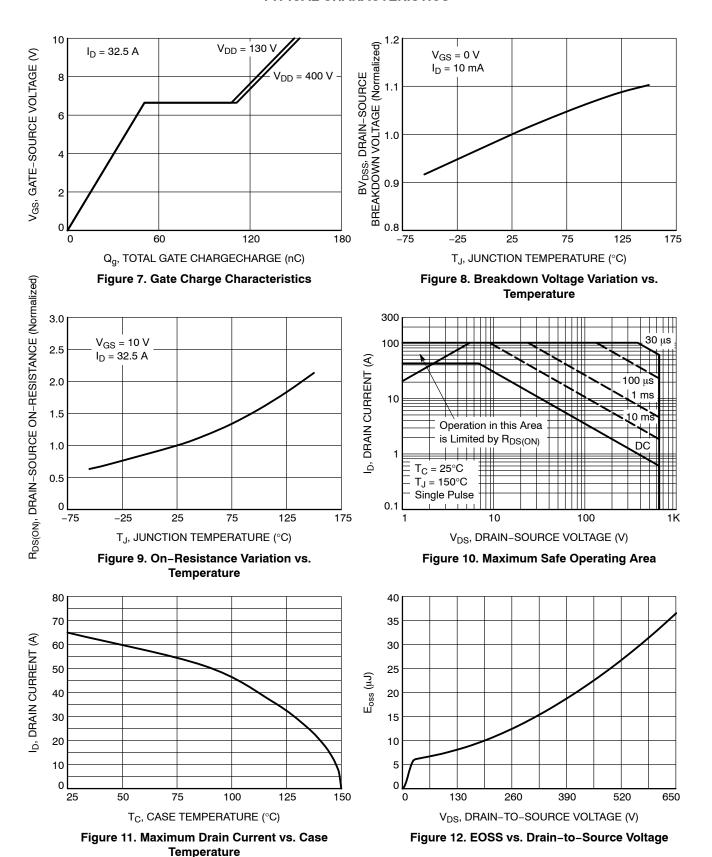
Figure 5. Body Diode Forward Voltage Variation vs. Source Current and Temperature



V_{DS}, DRAIN-TO-SOURCE VOLTAGE (V)

Figure 6. Capacitance Characteristics

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

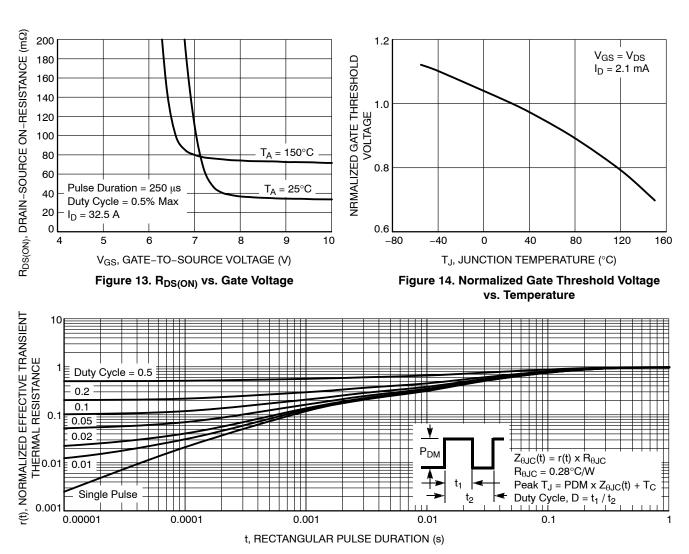


Figure 15. Transient Thermal Response Curve

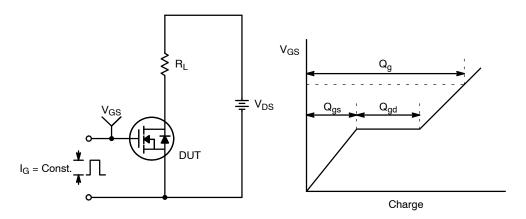


Figure 16. Gate Charge Test Circuit & Waveform

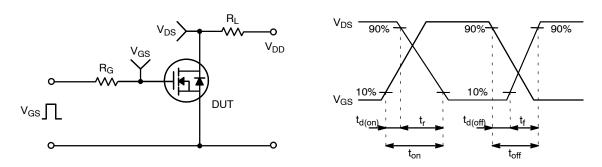


Figure 17. Resistive Switching Test Circuit & Waveforms

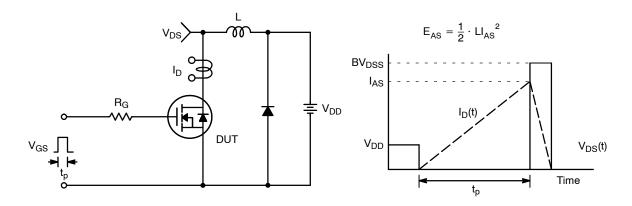


Figure 18. Unclamped Inductive Switching Test Circuit & Waveforms

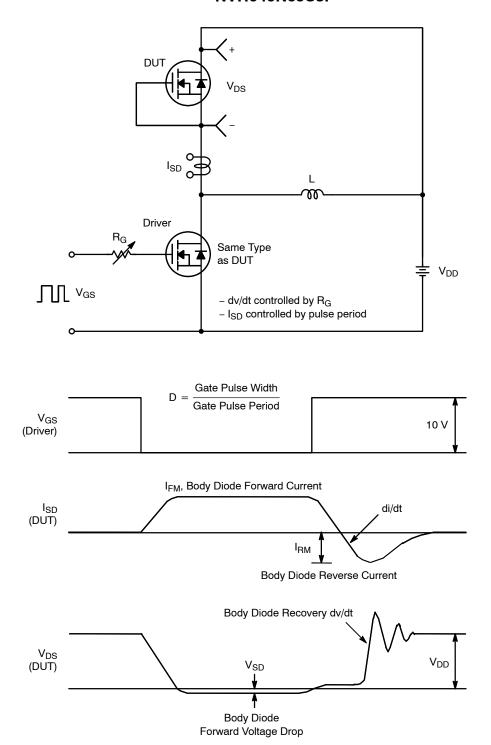
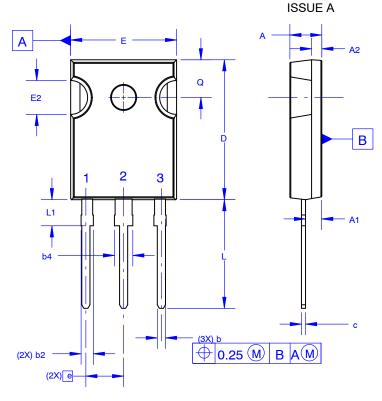


Figure 19. Peak Diode Recovery dv/dt Test Circuit & Waveforms

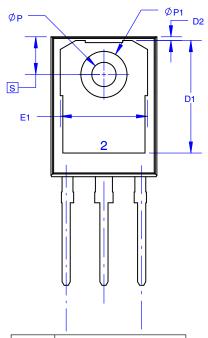
PACKAGE DIMENSIONS

TO-247-3LD SHORT LEAD CASE 340CK



NOTES: UNLESS OTHERWISE SPECIFIED.

- A. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- B. ALL DIMENSIONS ARE IN MILLIMETERS.
- C. DRAWING CONFORMS TO ASME Y14.5 2009.
- D. DIMENSION A1 TO BE MEASURED IN THE REGION DEFINED BY L1.
- E. LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY L1.



DIM	MILLIMETERS			
DIIVI	MIN	NOM	MAX	
Α	4.58	4.70	4.82	
A1	2.20	2.40	2.60	
A2	1.40	1.50	1.60	
b	1.17	1.26	1.35	
b2	1.53	1.65	1.77	
b4	2.42	2.54	2.66	
С	0.51	0.61	0.71	
D	20.32	20.57	20.82	
D1	13.08	~	~	
D2	0.51	0.93	1.35	
Е	15.37	15.62	15.87	
E1	12.81	~	~	
E2	4.96	5.08	5.20	
е	~	5.56	~	
L	15.75	16.00	16.25	
L1	3.69	3.81	3.93	
ØΡ	3.51	3.58	3.65	
ØP1	6.60	6.80	7.00	
Q	5.34	5.46	5.58	
S	5.34	5.46	5.58	

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